

RF Transformer

ADTL1-ED12740/1

Impedance Ratio : 1

Important Note

This model has been designed, built and tested in our engineering department. Performance data represents model capability. At present it is a non-catalog model. On request, we can supply a final specification sheet, part number and price/delivery information.



Please click "Back", and then click "Contact Us" for Applications support.

CASE STYLE : CD637

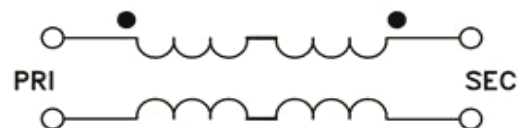
ELECTRICAL SPECIFICATIONS 50Ω @ +25°C				
Parameter		Min.	Typ.	Max. Units
Frequency		3		825 MHz
Insertion Loss *	3 dB Bandwidth		3 - 825	MHz
	2 dB Bandwidth		5 - 600	MHz
	1 dB Bandwidth		10 - 300	MHz

Note:

* Insertion Loss is referenced to mid-band loss, 0.12dB typ.

MAXIMUM RATINGS	
Operating Temperature	-20°C to 85°C
Storage Temperature	-55°C to 100°C
RF Power	0.25 W
DC Current	30 mA

Configuration : G

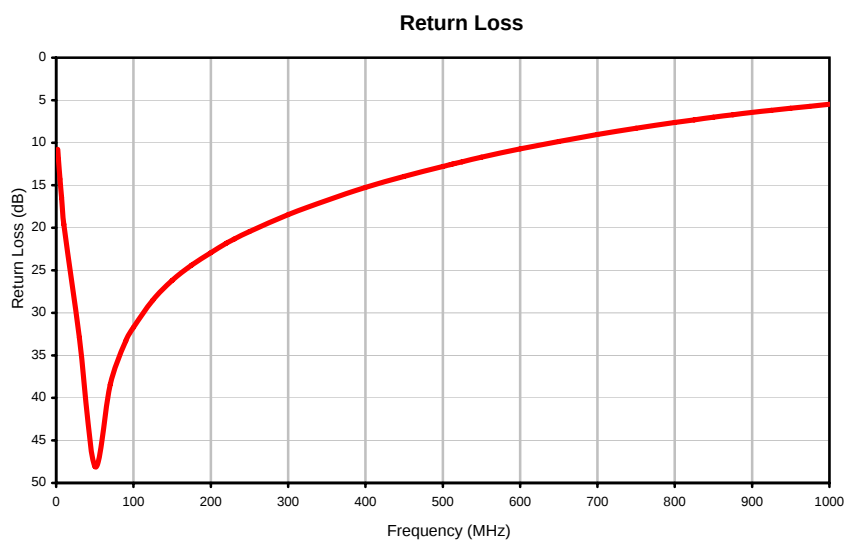
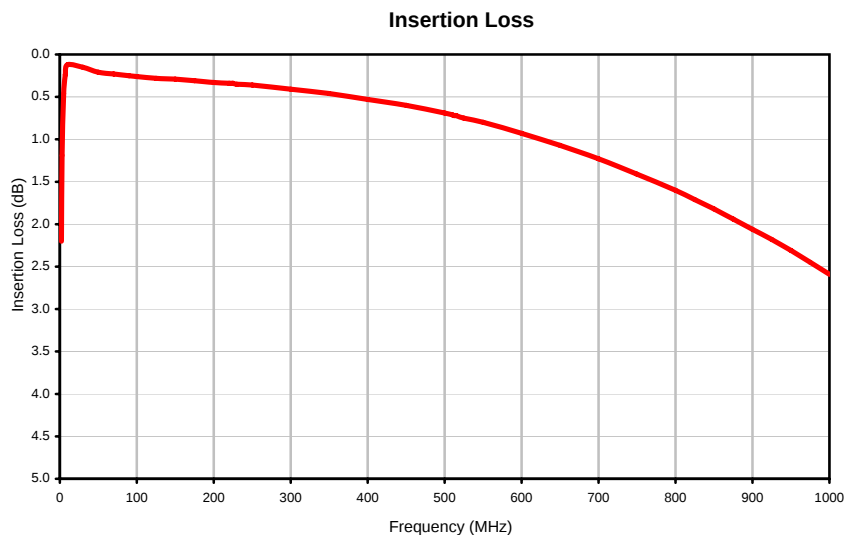


PIN CONNECTIONS	
PRIMARY DOT	1
PRIMARY	3
SECONDARY	6
SECONDARY CT	4
NOT USED	2,5

Typical Performance Data

FREQUENCY (MHz)	INSERTION LOSS (dB)	RETURN LOSS (dB)
2.00	2.20	10.78
3.00	1.19	11.89
5.00	0.46	14.28
7.00	0.24	16.46
10.00	0.12	19.60
30.00	0.15	32.91
50.00	0.21	48.06
70.00	0.23	38.44
90.00	0.25	33.31
100.00	0.26	31.71
125.00	0.28	28.52
150.00	0.29	26.19
175.00	0.31	24.40
200.00	0.33	22.93
220.00	0.34	21.83
225.00	0.34	21.57
230.00	0.35	21.33
250.00	0.36	20.44
300.00	0.41	18.46
350.00	0.46	16.78
400.00	0.53	15.26
450.00	0.60	13.96
500.00	0.69	12.79
510.00	0.71	12.57
512.00	0.72	12.53
515.00	0.72	12.46
525.00	0.75	12.24
550.00	0.80	11.70
600.00	0.93	10.73
650.00	1.07	9.85
700.00	1.23	9.03
750.00	1.41	8.29
800.00	1.60	7.62
825.00	1.71	7.31
850.00	1.82	7.00
875.00	1.94	6.71
900.00	2.06	6.44
925.00	2.18	6.18
950.00	2.31	5.94
975.00	2.45	5.71
1000.00	2.59	5.48

Typical Performance Curves



CD541
CD542
CD636
CD637

Outline Dimensions



PCB Land Pattern



Suggested Layout,
Tolerance to be within $\pm .002$

CASE#	A	B	C	D	E	F	G	H	J	K	L	WT, GRAM
CD541					.082 (2.08)							.15
CD542	.272 (6.91)	.310 (7.87)	.220 (5.58)	.100 (2.54)	.112 (2.84)	.055 (1.40)	.100 (2.54)	.030 (0.76)	.026 (0.66)	.065 (1.65)	.300 (7.62)	.20
CD636					.162 (4.11)							.25
CD637					.206 (5.23)							.40

Dimensions are in inches (mm). Tolerances: 2 Pl. $\pm .01$; 3 Pl. $\pm .005$

Notes:

- Case material: Plastic.
- Termination finish:
For RoHS Case Styles: Tin plate over Nickel plate. All models, (+) suffix.
For RoHS-5 Case Styles: Tin-Lead plate. All models, no (+) suffix.



INTERNET <http://www.minicircuits.com>

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Tape & Reel Packaging TR-F46



Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel
16	12	13	900

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

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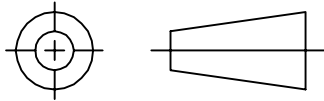
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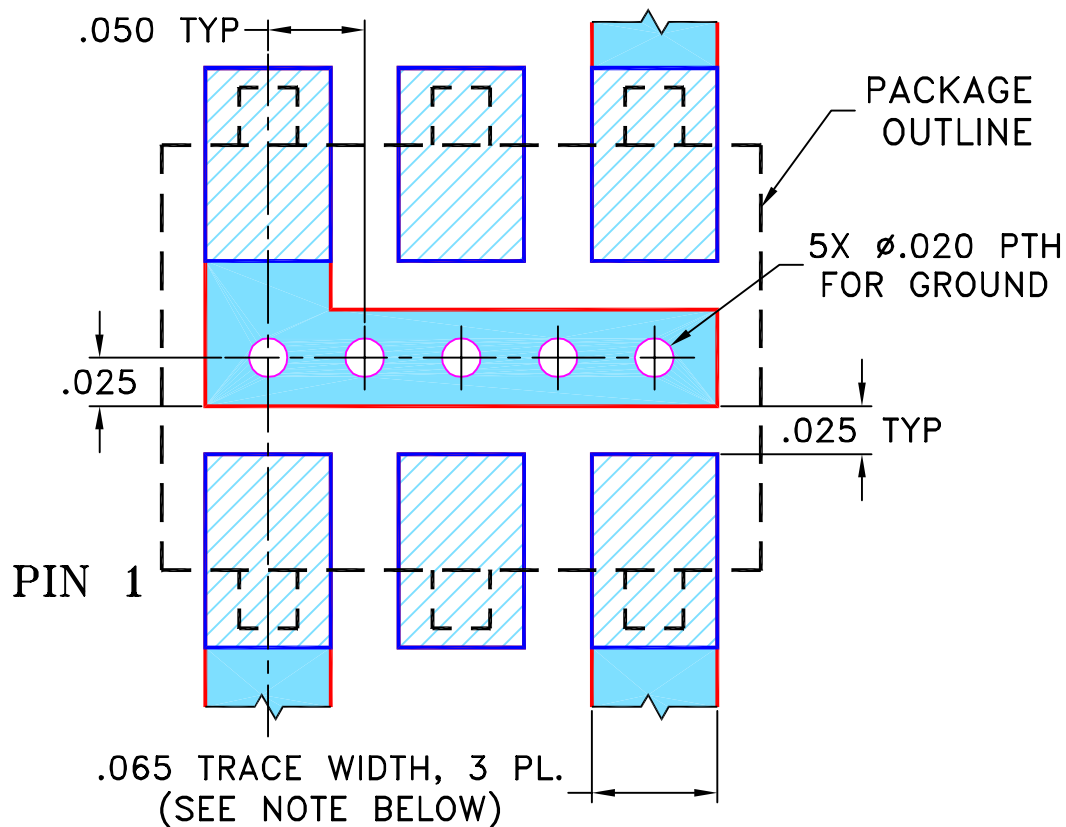
THIRD ANGLE PROJECTION



REVISIONS

REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
OR	M77049	NEW RELEASE	05/01	AV	CT
A	M82377	UPDATED DRAWING	07/31/02	AV	HY
B	M82846	UPDATED DRAWING	05/13/03	MMG	HY
C	M102713	ADDED BK292 CASE STYLE & "...WITH SMOBC"	01/17/06	MMG	IL

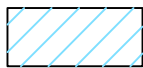
**SUGGESTED MOUNTING CONFIGURATION
FOR BK292/CD542/CD636 CASE STYLES,
"hv" PIN CONNECTION**



- NOTES:** 1. TRACE WIDTH IS SHOWN FOR ROGERS RO4350B WITH DIELECTRIC THICKNESS .030" $\pm$.002"; COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.
2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.



DENOTES PCB COPPER LAYOUT WITH SMOBC
(SOLDER MASK OVER BARE COPPER)



DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

UNLESS OTHERWISE SPECIFIED

INITIALS

DATE

DIMENSIONS ARE IN INCHES

TOLERANCES ON:

2 PL DECIMALS $\pm$ 3 PL DECIMALS $\pm$.005ANGLES $\pm$ FRACTIONS $\pm$

DRAWN

AV

05/30/01

CHECKED

DY

06/11/01

APPROVED

CT

06/11/01

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ASHEETA1.DWG REV:A DATE:01/12/95



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13 Neptune Avenue
Brooklyn NY 11235

PL, hv, BK292/CD542/CD636, ADP/JPS, TB-48

SIZE

A

CODE IDENT

15542

DRAWING NO:

98-PL-035

REV:

C

FILE: 98PL035

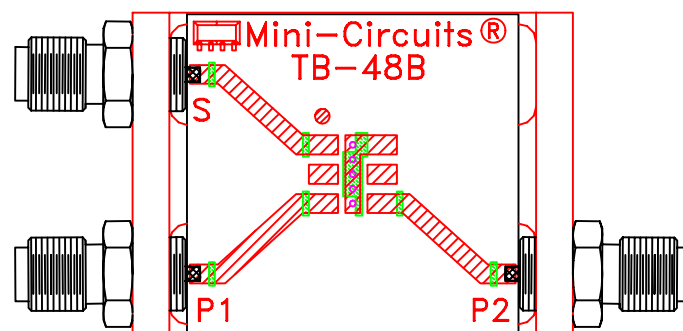
SCALE:

10:1

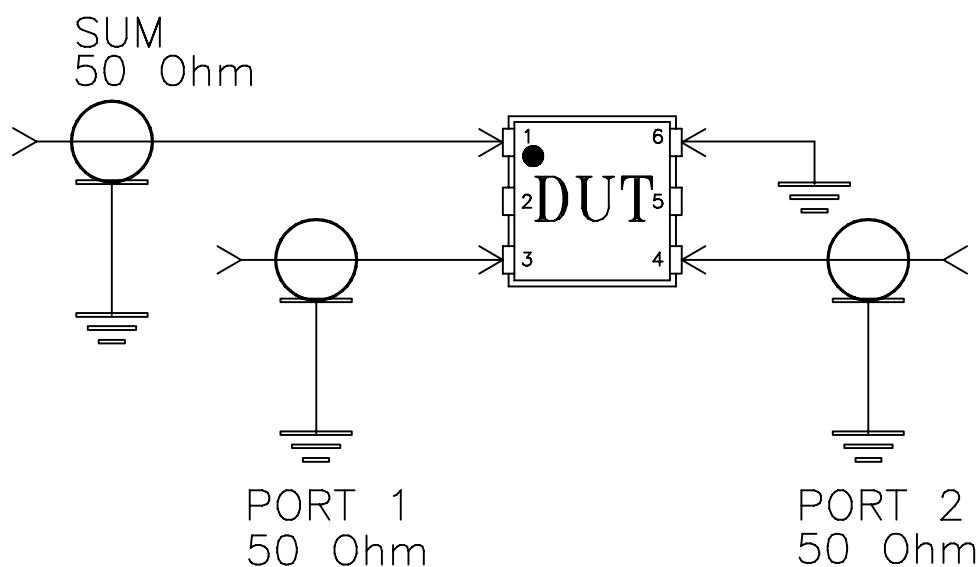
SHEET:

1 OF 1

Evaluation Board and Circuit



TB-48+



Schematic Diagram

Notes:

1. SMA Female connectors.
2. PCB Material: Rogers R04350 or equivalent,
Dielectric Constant=3.5, Thickness=.030 inch.

 **Mini-Circuits®**



All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-20° to 85°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Thermal Shock	-55° to 100°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, except +100°C
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A
Marking Resistance to Solvents	Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C; distilled water + proylene glycol monomethyl ether + monoethanolamine at 63°C to 70°C	MIL-STD-202, Method 215